



**MOTOROLA**

<b>1N5820</b>	<b>MBR320P</b>
<b>1N5821</b>	<b>MBR330P</b>
<b>1N5822</b>	<b>MBR340P</b>

## Designers Data Sheet

### AXIAL LEAD RECTIFIERS

employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low  $v_f$
- Low Power Loss High Efficiency
- Low Stored Charge, Majority Carrier Conduction

#### Designer's Data for Worst-Case Conditions

The Designers' Data sheets permit the design of most circuits entirely from the information presented. Limit curves representing boundaries on device characteristics are given to facilitate worst-case design.

#### \*MAXIMUM RATINGS

Rating	Symbol	1N5820 MBR320P	1N5821 MBR330P	1N5822 MBR340P	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{WRM}$ $V_R$	20	30	40	V
Non-Repetitive Peak Reverse Voltage	$V_{RSRM}$	24	36	48	V
RMS Reverse Voltage	$V_R(RMS)$	14	21	28	V
Average Rectified Forward Current (2) $V_R(\text{Requis.}) = 0.2 \sqrt{V_R(\text{dc})} T_L - 95^\circ\text{C}$ $(V_{FJA} = 28^\circ\text{C W P.C. Board}$ Mounting, see Note 2)	$I_F$	10	3.0	4	A
Ambient Temperature Rated $V_R(\text{dc}), P_F(\text{AV}) = 0$ $R_{FJA} = 28^\circ\text{C W}$	$T_A$	90	65	80	$^\circ\text{C}$
Non Repetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase 60 Hz, $T_L = 75^\circ\text{C}$ )	$I_{FSM}$	80 (from note 2)			A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	$T_J, T_{Stg}$	-65 to +125			$^\circ\text{C}$
Peak Operating Junction Temperature (Forward Current Applied)	$T_J(pk)$	150			$^\circ\text{C}$

#### \*THERMAL CHARACTERISTICS (Note 2)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{FJA}$	28	$^\circ\text{C/W}$

#### \*ELECTRICAL CHARACTERISTICS ( $T_L = 25^\circ\text{C}$ unless otherwise noted) (2)

Characteristic	Symbol	1N5820	1N5821	1N5822	MBR --P	Unit
Maximum Instantaneous Forward Voltage (1)	$v_F$					V
( $i_F = 1.0 \text{ Amp}$ )		0.370	0.380	0.390	0.400	
( $i_F = 3.0 \text{ Amp}$ )		0.475	0.500	0.525	0.550	
( $i_F = 9.4 \text{ Amp}$ )		0.850	0.900	0.950	0.950	
Maximum Instantaneous Reverse Current @ Rated dc Voltage (1)	$i_R$					mA
( $T_L = 25^\circ\text{C}$ )		2.0	2.0	2.0	2.0	
( $T_L = 100^\circ\text{C}$ )		20	20	20	20	

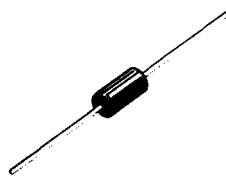
(1) Pulse Test. Pulse Width = 300  $\mu\text{s}$ , Duty Cycle = 2 0%.

(2) Lead Temperature reference is cathode lead 1/32" from case

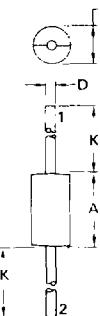
\*Indicates JEDEC Registered Data for 1N5820 22

### SCHOTTKY BARRIER RECTIFIERS

3.0 AMPERES  
20, 30, 40 VOLTS



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DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.40	9.65	0.370	0.380
B	4.83	5.33	0.190	0.210
D	1.22	1.32	0.048	0.052
K	26.97	27.23	1.062	1.072

CASE 267.01

### MECHANICAL CHARACTERISTICS

CASE . . . . . Transfer molded plastic  
FINISH . . . . . All external surfaces

corrosion-resistant and the terminal  
leads are readily solderable

POLARITY . . . . . Cathode indicated by  
polarity band

MOUNTING POSITIONS . . . . . Any

SOLDERING . . . . . 220°C 1:16" from case  
for ten seconds

# 1N5820, 1N5821, 1N5822, MBR320P, MBR330P, MBR340P

## NOTE 1 – DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1 VRWM. Proper derating may be accomplished by use of equation (1).

$$T_A(\text{max}) = T_J(\text{max}) - R_{HJA}P_F(AV) - R_{HJA}P_R(AV) \quad (1)$$

where  $T_A(\text{max})$  = Maximum allowable ambient temperature

$T_J(\text{max})$  = Maximum allowable junction temperature  
(125°C or the temperature at which thermal runaway occurs, whichever is lower)

$P_F(AV)$  = Average forward power dissipation

$P_R(AV)$  = Average reverse power dissipation

$R_{HJA}$  = Junction-to-ambient thermal resistance

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2)

$$T_R = T_J(\text{max}) - R_{HJA}P_F(AV) \quad (2)$$

Substituting equation (2) into equation (1) yields

$$T_A(\text{max}) = T_R - R_{HJA}P_F(AV) \quad (3)$$

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^\circ\text{C}$ , when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the

slope in the vicinity of 115°C. The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table I indicates suggested factors for an equivalent dc voltage to use for conservative design, that is,

$$V_R(\text{equiv}) = V(FM) \times F \quad (4)$$

The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE Find  $T_A(\text{max})$  for 1N5821 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that  $I_{DC} = 2.0 \text{ A}$  ( $I_{F(AV)} = 1.0 \text{ A}$ ),  $I_{(FM)} = 10$  Input Voltage = 10 VRMS,  $R_{HJA} = 40^\circ\text{C/W}$

Step 1. Find  $V_R(\text{equiv})$ . Read  $F = 0.65$  from Table I.

$$\therefore V_R(\text{equiv}) = (1.41)(110)(0.65) = 9.2 \text{ V}$$

Step 2. Find  $T_R$  from Figure 2. Read  $T_R = 108^\circ\text{C}$

$$\therefore V_R = 9.2 \text{ V and } R_{HJA} = 40^\circ\text{C/W}$$

Step 3. Find  $P_F(AV)$  from Figure 6. \*Read  $P_F(AV) = 0.85 \text{ W}$

$$\therefore \frac{I_{(FM)}}{I_{AV}} = 10 \text{ and } I_{F(AV)} = 1.0 \text{ A.}$$

Step 4. Find  $T_A(\text{max})$  from equation (3)

$$T_A(\text{max}) = 108 - (0.85)(40) = 74^\circ\text{C.}$$

\*Values given are for the 1N5821. Power is slightly lower for the 1N5820 because of its lower forward voltage, and higher for the 1N5822. Variations will be similar for the MBR-prefix devices, using  $P_F(AV)$  from Figure 7.

TABLE 1 – VALUES FOR FACTOR F

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Center Tapped*†	
	Load	Resistive	Capacitive*	Resistive	Capacitive	Resistive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

\*Note that  $V_R(PK) \approx 2.0 \text{ V}_{int}(PK)$ . †Use one-half center tap voltage for  $V_{in}$ .

FIGURE 1 – MAXIMUM REFERENCE TEMPERATURE  
1N5820/MBR320P

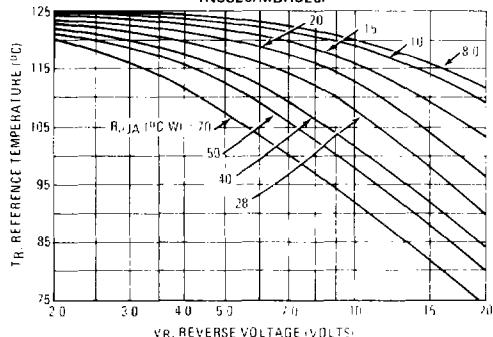


FIGURE 3 – MAXIMUM REFERENCE TEMPERATURE  
1N5822/MBR340P

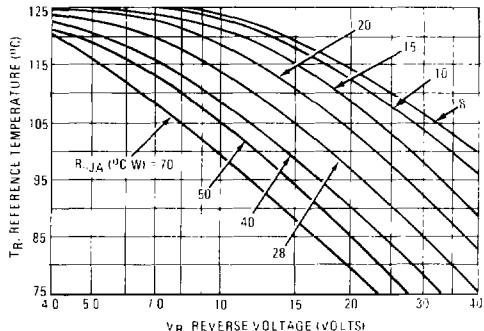


FIGURE 2 – MAXIMUM REFERENCE TEMPERATURE  
1N5821/MBR330P

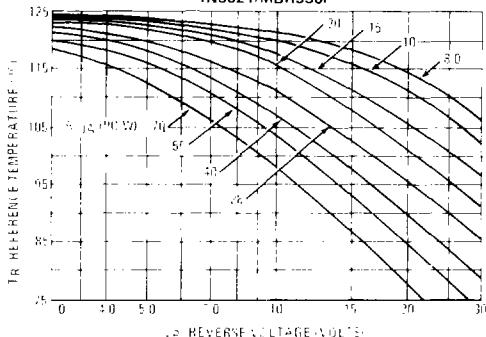
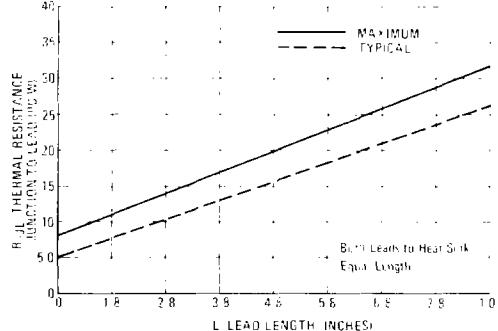


FIGURE 4 – STEADY-STATE THERMAL RESISTANCE



# 1N5820, 1N5821, 1N5822, MBR320P, MBR330P, MBR340P

FIGURE 5 – THERMAL RESPONSE

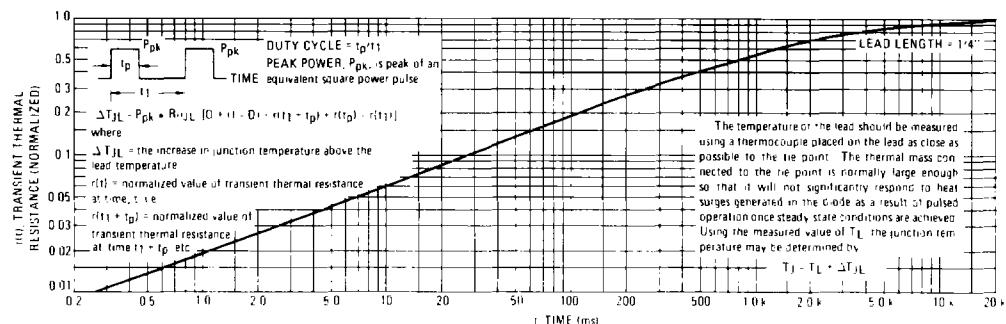


FIGURE 6 – FORWARD POWER DISSIPATION  
1N5820-22

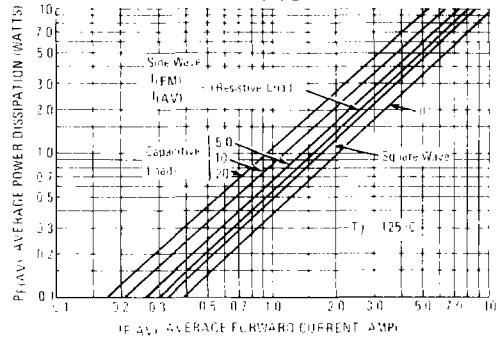
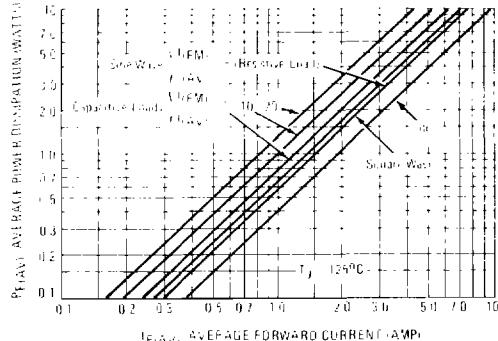


FIGURE 7 – FORWARD POWER DISSIPATION  
MBR320P-340P



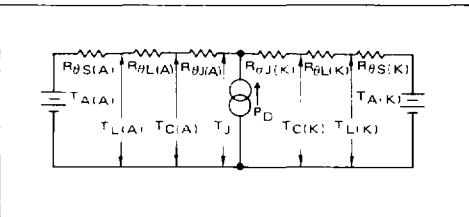
NOTE 2 – MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR  $R_{\theta JA}$  IN STILL AIR

Mounting Method	Lead Length, L (in)				$R_{\theta JA}$
	1/8	1/4	1/2	3/4	
1	55	31	53	65	8°C/W
2	36	49	61	62	8°C/W
3		28			8°C/W

NOTE 3 – APPROXIMATE THERMAL CIRCUIT MODEL



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

$T_A$  = Ambient Temperature       $T_C$  = Case Temperature  
 $T_L$  = Lead Temperature       $T_J$  = Junction Temperature  
 $R_{\theta S}$  = Thermal Resistance, Heat Sink to Ambient  
 $R_{\theta L}$  = Thermal Resistance, Lead to Heat Sink  
 $R_{\theta J}$  = Thermal Resistance, Junction to Case  
 $P_D$  = Total Power Dissipation =  $P_F + P_R$   
 $P_F$  = Forward Power Dissipation  
 $P_R$  = Reverse Power Dissipation  
 Subscripts (A) and (K) refer to anode and cathode sides, respectively. Values for thermal resistance components are:  
 $R_{\theta JL}$  = 42°C/W typically and 48°C/W maximum  
 $R_{\theta J}$  = 10°C/W typically and 16°C/W maximum

The maximum lead temperature may be found as follows

$$T_L = T_J(\max) - \Delta T_{JL}$$

where  $\Delta T_{JL} = R_{\theta JL} \cdot P_D$

#### Mounting Method 1

P.C. Board where available copper surface is small



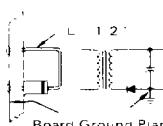
#### Mounting Method 2

Vector Push In Terminals T-28



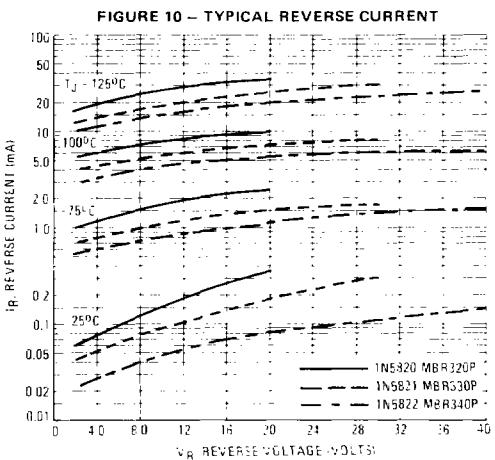
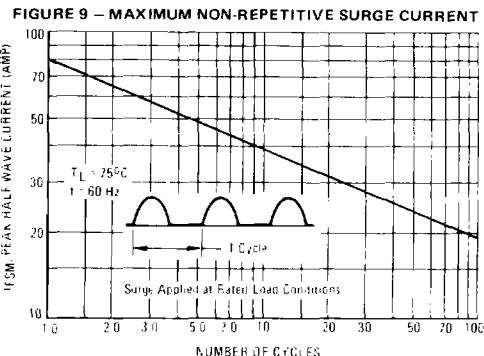
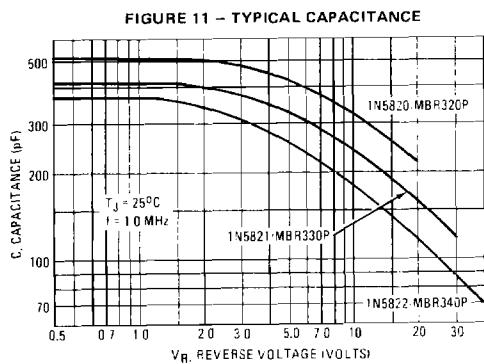
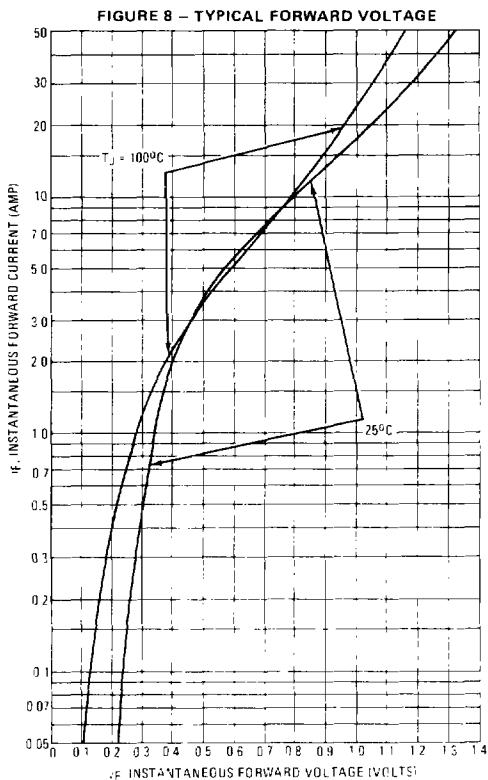
#### Mounting Method 3

P.C. Board with 2 1/2" x 2 1/2" copper surface



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#### NOTE 4 – HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 11.)